1SX250LH3F55E3VG Information

Part Number	1SX250LH3F55E3VG
Manufacturer	Intel
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Description	2912-PIN FBGA
Package	-

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

For Reference Only

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

1SX250LH3F55E3VG Specifications

Manufacturer Part Number	1SX250LH3F55E3VG
Manufacturer	Intel
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Package	-
Series	Stratix® 10 SX
Architecture	MCU, FPGA
Core Processor	Quad ARM® Cortex®-A53 MPCore™ with CoreSight™
Flash Size	-
RAM Size	256KB
Peripherals	DMA, WDT
Connectivity	EBI/EMI, Ethernet, I²C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	1.5GHz
Primary Attributes	FPGA - 2500K Logic Elements
Operating Temperature	0°C ~ 100°C (TJ)
Package / Case	-
Supplier Device Package	-

Report errors?

1SX250LH3F55E3VG Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

1SX250LH3F55E3VG Payment Methods

1SX250LH3F55E3VG Shipping Methods

If you have any question about 1SX250LH3F55E3VG, please do not hesitate to contact us!
Website: https://www.heisener.com
E-mail: salesdept@heisener.com